

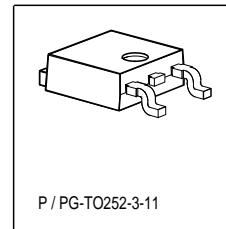


Features

- Logic Level Input
- Input Protection (ESD)
- Thermal shutdown with auto restart
- Green product (RoHS compliant)
- Overload protection
- Short circuit protection
- Overvoltage protection
- Current limitation
- Analog driving possible

Product Summary

Drain source voltage	V_{DS}	42	V
On-state resistance	$R_{DS(on)}$	28	$\text{m}\Omega$
Nominal load current	$I_D(\text{Nom})$	4.6	A
Clamping energy	E_{AS}	3.5	J

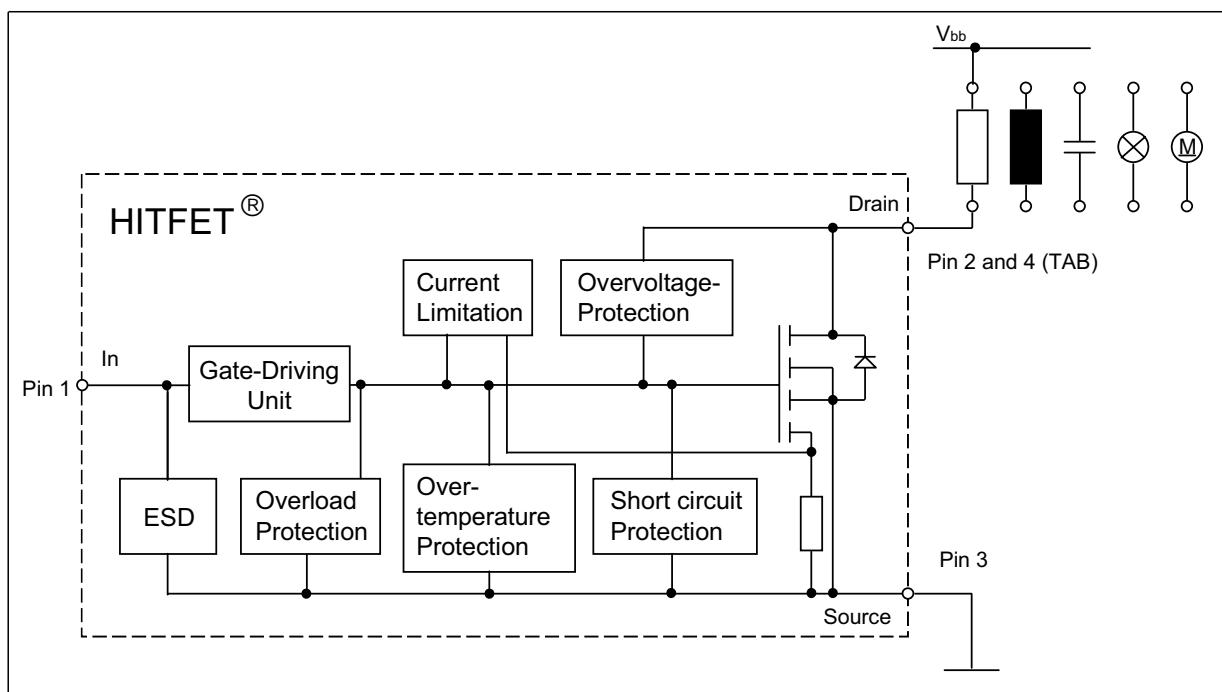


Application

- All kinds of resistive, inductive and capacitive loads in switching or linear applications
- µC compatible power switch for 12 V DC applications
- Replaces electromechanical relays and discrete circuits

General Description

N channel vertical power FET in Smart SIPMOS® technology. Fully protected by embedded protection functions.



Complete product spectrum and additional information <http://www.infineon.com/hitfet>

Maximum Ratings at $T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Value	Unit
Drain source voltage	V_{DS}	42	V
Supply voltage for full short circuit protection	$V_{bb(\text{SC})}$	42	
Continuous input voltage ¹⁾	V_{IN}	-0.2 ²⁾ ... +10	
Continuous input current ²⁾ $-0.2\text{V} \leq V_{IN} \leq 10\text{V}$ $V_{IN} < -0.2\text{V}$ or $V_{IN} > 10\text{V}$	I_{IN}	self limited $ I_{IN} \leq 2$	mA
Operating temperature	T_j	-40 ... +150	$^\circ\text{C}$
Storage temperature	T_{stg}	-55 ... +150	
Power dissipation ⁵⁾ $T_C = 85^\circ\text{C}$ 6cm ² cooling area , $T_A = 85^\circ\text{C}$	P_{tot}	59 1.1	W
Unclamped single pulse inductive energy ²⁾	E_{AS}	3.5	J
Load dump protection $V_{LoadDump}^{2)3)} = V_A + V_S$ $V_{IN} = 0$ and 10V , $t_d = 400\text{ ms}$, $R_L = 2\Omega$, $R_L = 3\Omega$, $V_A = 13.5\text{V}$	V_{LD}	67.5	V
Electrostatic discharge voltage ²⁾ (Human Body Model) according to Jedec norm EIA/JESD22-A114-B, Section 4	V_{ESD}	2	kV

Thermal resistance

junction - case:	R_{thJC}	1.1	K/W
SMD: junction - ambient @ min. footprint	R_{thJA}	115	
@ 6 cm ² cooling area ⁴⁾		55	

¹⁾For input voltages beyond these limits I_{IN} has to be limited.

²⁾not subject to production test, specified by design

³⁾ $V_{Loaddump}$ is setup without the DUT connected to the generator per ISO 7637-1 and DIN 40839

⁴⁾ Device on 50mm*50mm*1.5mm epoxy PCB FR4 with 6cm² (one layer, 70µm thick) copper area for drain connection. PCB mounted vertical without blown air.

⁵⁾not subject to production test, calculated by R_{thJA} and $R_{ds(on)}$

Electrical Characteristics

Parameter	Symbol	Values			Unit		
		min.	typ.	max.			
at $T_j = 25^\circ\text{C}$, unless otherwise specified							
Characteristics							
Drain source clamp voltage $T_j = -40 \dots +150^\circ\text{C}, I_D = 10 \text{ mA}$	$V_{DS(AZ)}$	42	-	55	V		
Off-state drain current $T_j = -40 \dots +85^\circ\text{C}, V_{DS} = 32 \text{ V}, V_{IN} = 0 \text{ V}$ $T_j = 150^\circ\text{C}$	I_{DSS}	-	1.5	8	μA		
-		-	10	20			
Input threshold voltage $I_D = 2.4 \text{ mA}, T_j = 25^\circ\text{C}$ $I_D = 2.4 \text{ mA}, T_j = 150^\circ\text{C}$	$V_{IN(th)}$	1.3	1.7	2.2	V		
-		0.8	-	-			
On state input current	$I_{IN(on)}$	-	10	30	μA		
On-state resistance $V_{IN} = 5 \text{ V}, I_D = 4.6 \text{ A}, T_j = 25^\circ\text{C}$ $V_{IN} = 5 \text{ V}, I_D = 4.6 \text{ A}, T_j = 150^\circ\text{C}$	$R_{DS(on)}$	-	27	34	$\text{m}\Omega$		
-		-	54	68			
On-state resistance $V_{IN} = 10 \text{ V}, I_D = 4.6 \text{ A}, T_j = 25^\circ\text{C}$ $V_{IN} = 10 \text{ V}, I_D = 4.6 \text{ A}, T_j = 150^\circ\text{C}$	$R_{DS(on)}$	-	23	28			
-		-	46	56			
Nominal load current 5) $T_j < 150^\circ\text{C}, V_{IN} = 10 \text{ V}, T_A = 85^\circ\text{C}, \text{SMD } 1)$	$I_{D(Nom)}$	4.6	5.5	-	A		
Nominal load current 5) $V_{IN} = 10 \text{ V}, V_{DS} = 0.5 \text{ V}, T_C = 85^\circ\text{C}, T_j < 150^\circ\text{C}$	$I_{D(ISO)}$	12.6	15.3	-			
Current limit (active if $V_{DS} > 2.5 \text{ V}$) ²⁾ $V_{IN} = 10 \text{ V}, V_{DS} = 12 \text{ V}, t_m = 200 \mu\text{s}$	$I_{D(lim)}$	30	45	55			

¹@ 6 cm² cooling area

²Device switched on into existing short circuit (see diagram Determination of $I_{D(lim)}$). If the device is in on condition and a short circuit occurs, these values might be exceeded for max. 50 μs .

⁵not subject to production test, calculated by R_{thJA} and $R_{ds(on)}$

Electrical Characteristics

Parameter at $T_j = 25^\circ\text{C}$, unless otherwise specified	Symbol	Values			Unit
		min.	typ.	max.	

Dynamic Characteristics

Turn-on time V_{IN} to 90% I_D : $R_L = 4.7 \Omega$, $V_{IN} = 0$ to 10 V, $V_{bb} = 12$ V	t_{on}	-	60	120	μs
Turn-off time V_{IN} to 10% I_D : $R_L = 4.7 \Omega$, $V_{IN} = 10$ to 0 V, $V_{bb} = 12$ V	t_{off}	-	60	120	
Slew rate on 70 to 50% V_{bb} : $R_L = 4.7 \Omega$, $V_{IN} = 0$ to 10 V, $V_{bb} = 12$ V	$-\text{d}V_{DS}/\text{d}t_{on}$	-	0.3	1.5	
Slew rate off 50 to 70% V_{bb} : $R_L = 4.7 \Omega$, $V_{IN} = 10$ to 0 V, $V_{bb} = 12$ V	$\text{d}V_{DS}/\text{d}t_{off}$	-	0.3	1.5	

Protection Functions¹⁾

Thermal overload trip temperature	T_{jt}	150	175	-	$^\circ\text{C}$
Thermal hysteresis ²⁾	ΔT_{jt}	-	10	-	K
Input current protection mode $T_j = 150$ °C	$I_{IN(\text{Prot})}$	-	180	400	μA
Unclamped single pulse inductive energy ²⁾ $I_D = 4.6$ A, $T_j = 25$ °C, $V_{bb} = 12$ V	E_{AS}	3.5	-	-	J

Inverse Diode

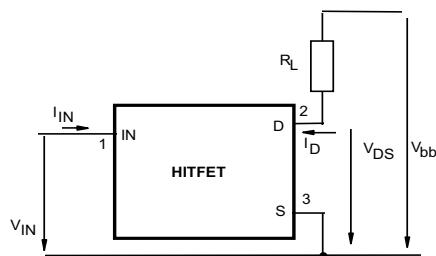
Inverse diode forward voltage $I_F = 51$ A, $t_m = 250$ μs , $V_{IN} = 0$ V, $t_P = 300$ μs	V_{SD}	-	1.0	1.5	V
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¹⁾ Integrated protection functions are designed to prevent IC destruction under fault conditions described in the data sheet. Fault conditions are considered as "outside" normal operating range. Protection functions are not designed for continuous repetitive operation.

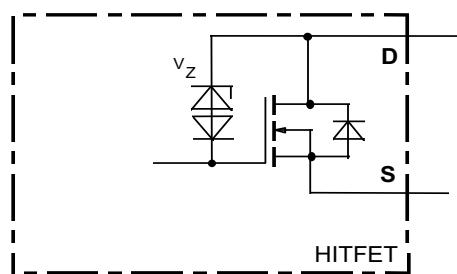
²⁾ not subject to production test, specified by design

Block diagram

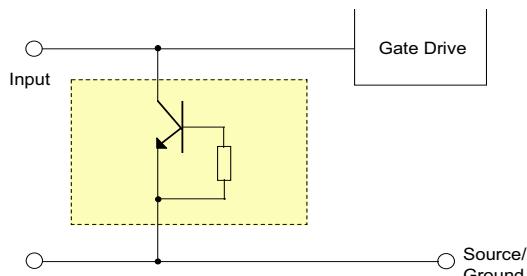
Terms



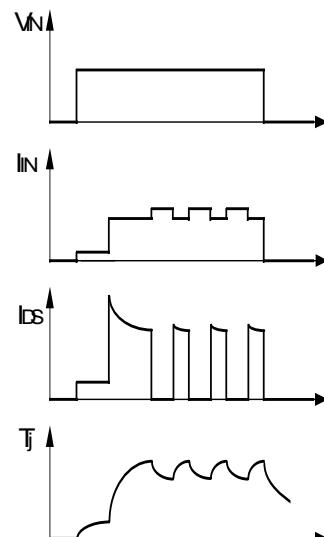
Inductive and overvoltage output clamp



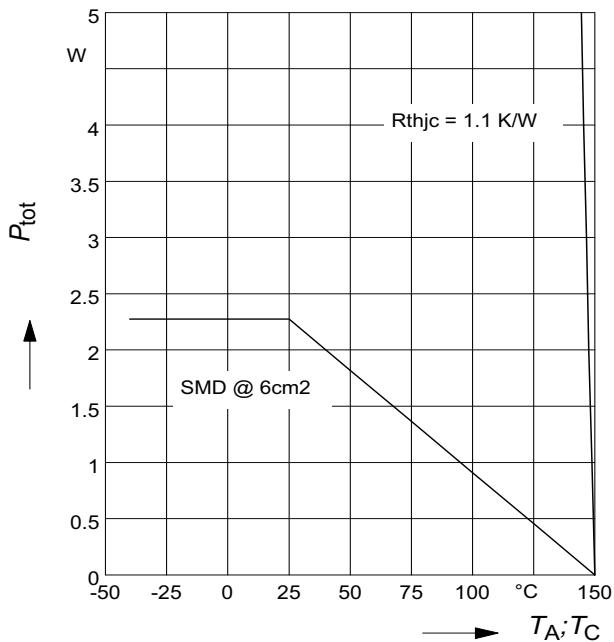
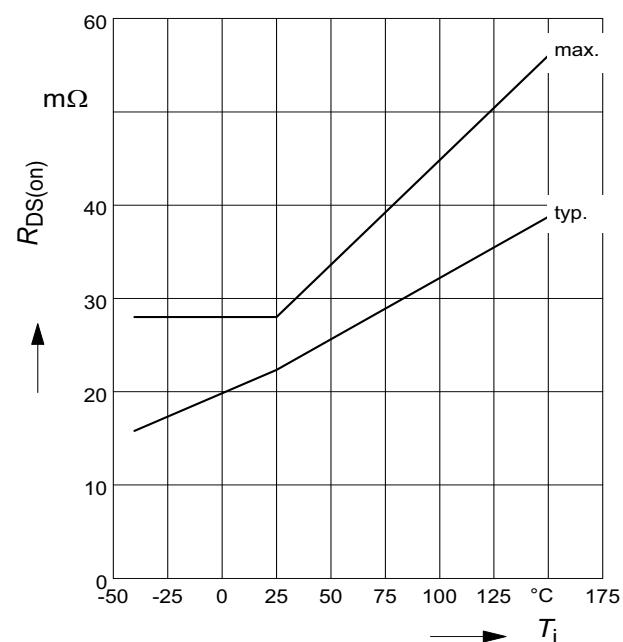
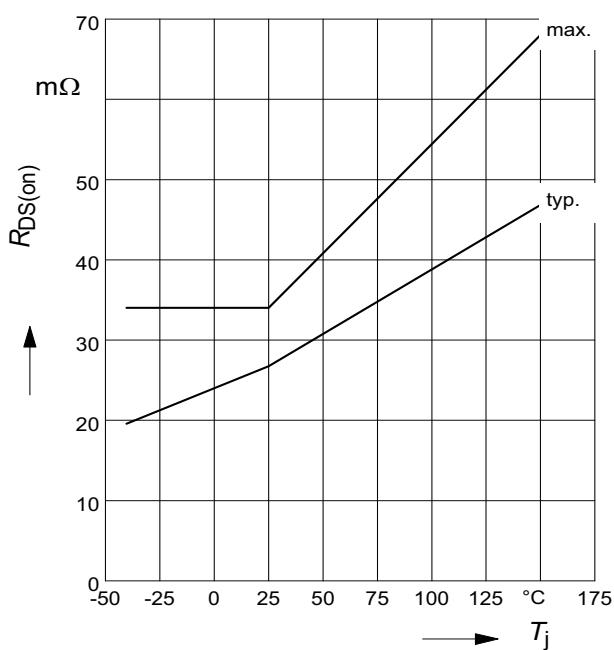
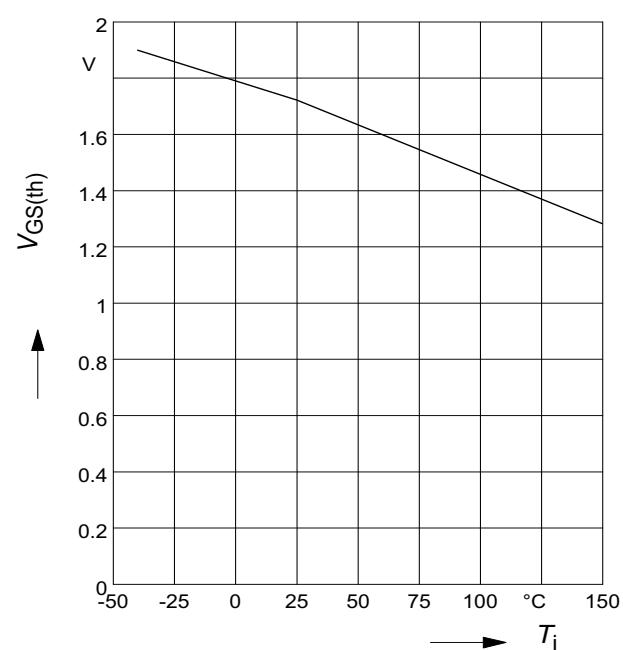
Input circuit (ESD protection)



Short circuit behaviour

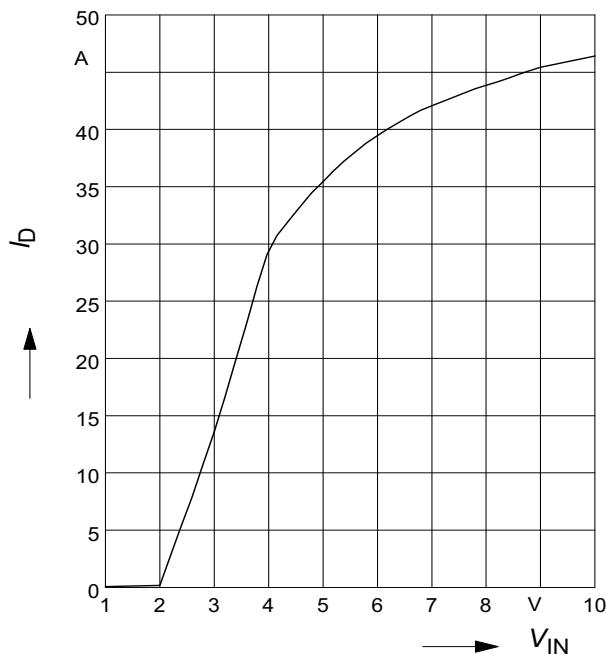


1 Maximum allowable power dissipation
 $P_{\text{tot}} = f(T_C)$ resp.

 $P_{\text{tot}} = f(T_A) @ R_{\text{thJA}}=55 \text{ K/W}$

2 On-state resistance
 $R_{\text{ON}} = f(T_j); I_D = 12.6 \text{ A}; V_{\text{IN}} = 10 \text{ V}$

3 On-state resistance
 $R_{\text{ON}} = f(T_j); I_D = 12.6 \text{ A}; V_{\text{IN}} = 5 \text{ V}$

4 Typ. input threshold voltage
 $V_{\text{IN}(\text{th})} = f(T_j); I_D = 1.2 \text{ mA}; V_{\text{DS}} = 12 \text{ V}$


5 Typ. transfer characteristics

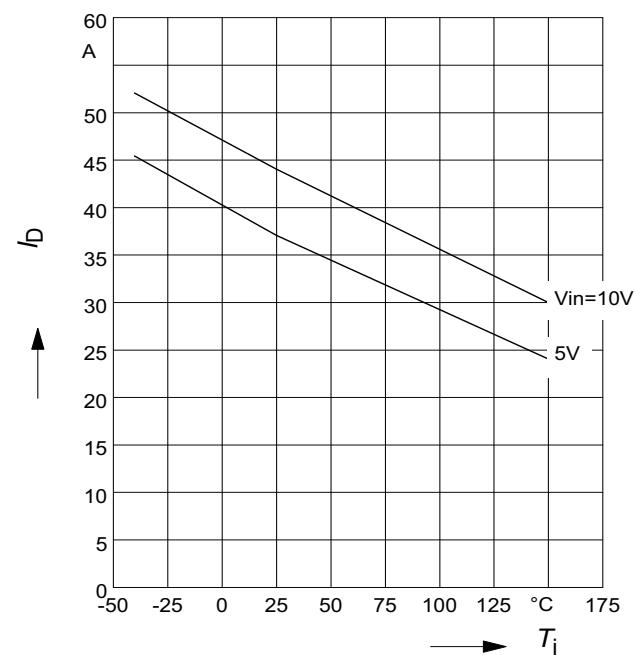
$I_D = f(V_{IN})$; $V_{DS} = 12V$; $T_{Jstart} = 25^\circ C$



6 Typ. short circuit current

$I_D(\text{lim}) = f(T_j)$; $V_{DS} = 12V$

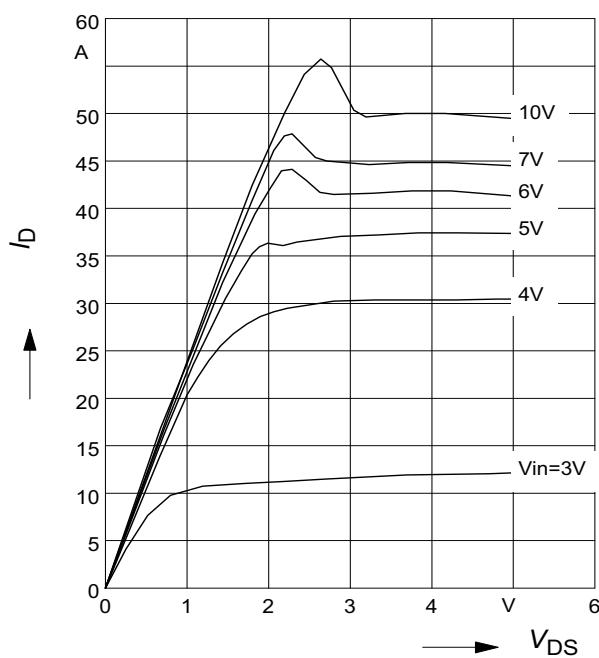
Parameter: V_{IN}



7 Typ. output characteristics

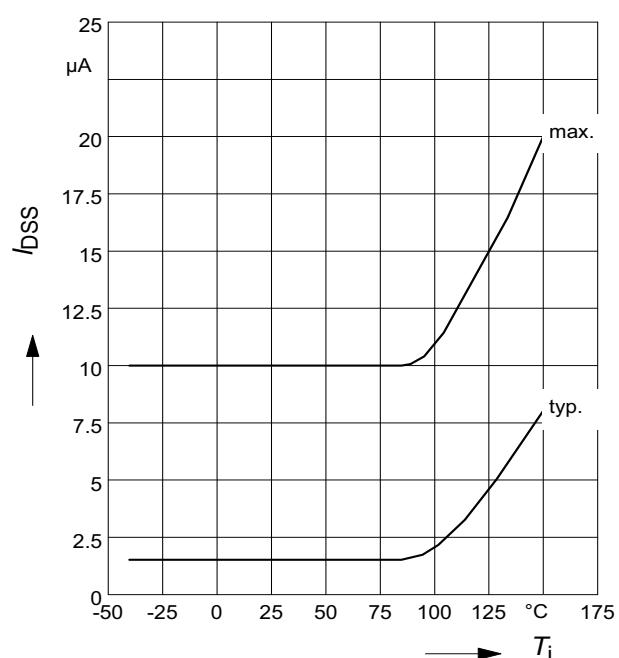
$I_D = f(V_{DS})$; $T_{Jstart} = 25^\circ C$

Parameter: V_{IN}

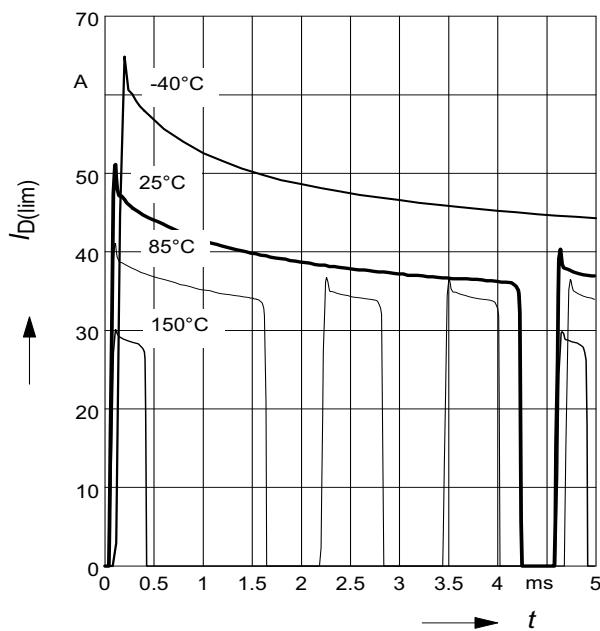


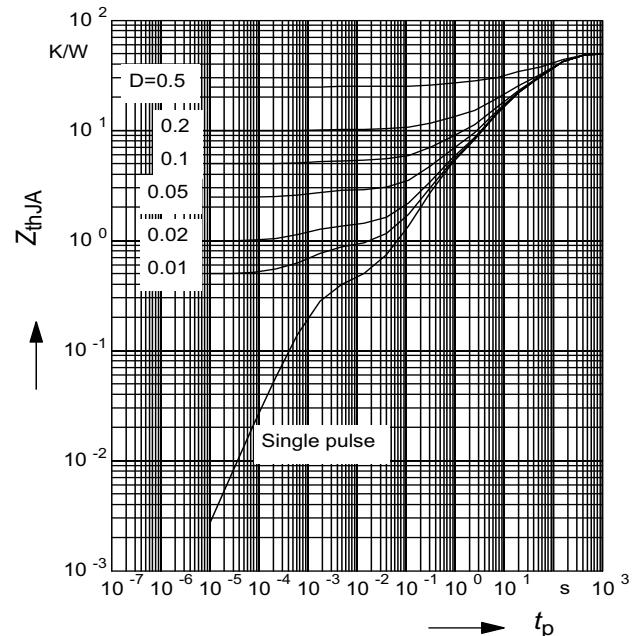
8 Off-state drain current

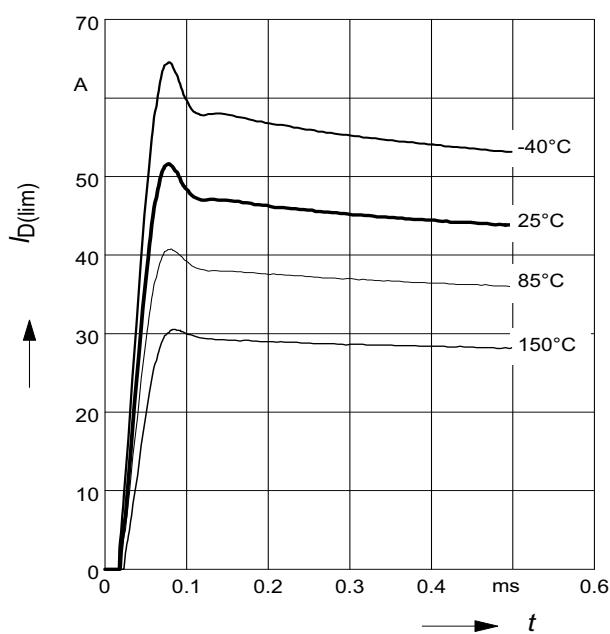
$I_{DSS} = f(T_j)$



9 Typ. overload current
 $I_{D(\text{lim})} = f(t)$, $V_{bb}=12 \text{ V}$, no heatsink

 Parameter: $T_{j\text{start}}$

10 Typ. transient thermal impedance
 $Z_{\text{thJA}} = f(t_p) @ 6 \text{ cm}^2 \text{ cooling area}$

 Parameter: $D=t_p/T$

11 Determination of $I_{D(\text{lim})}$
 $I_{D(\text{lim})} = f(t); t_m = 200\mu\text{s}$

 Parameter: $T_{j\text{start}}$


1 Package Outlines

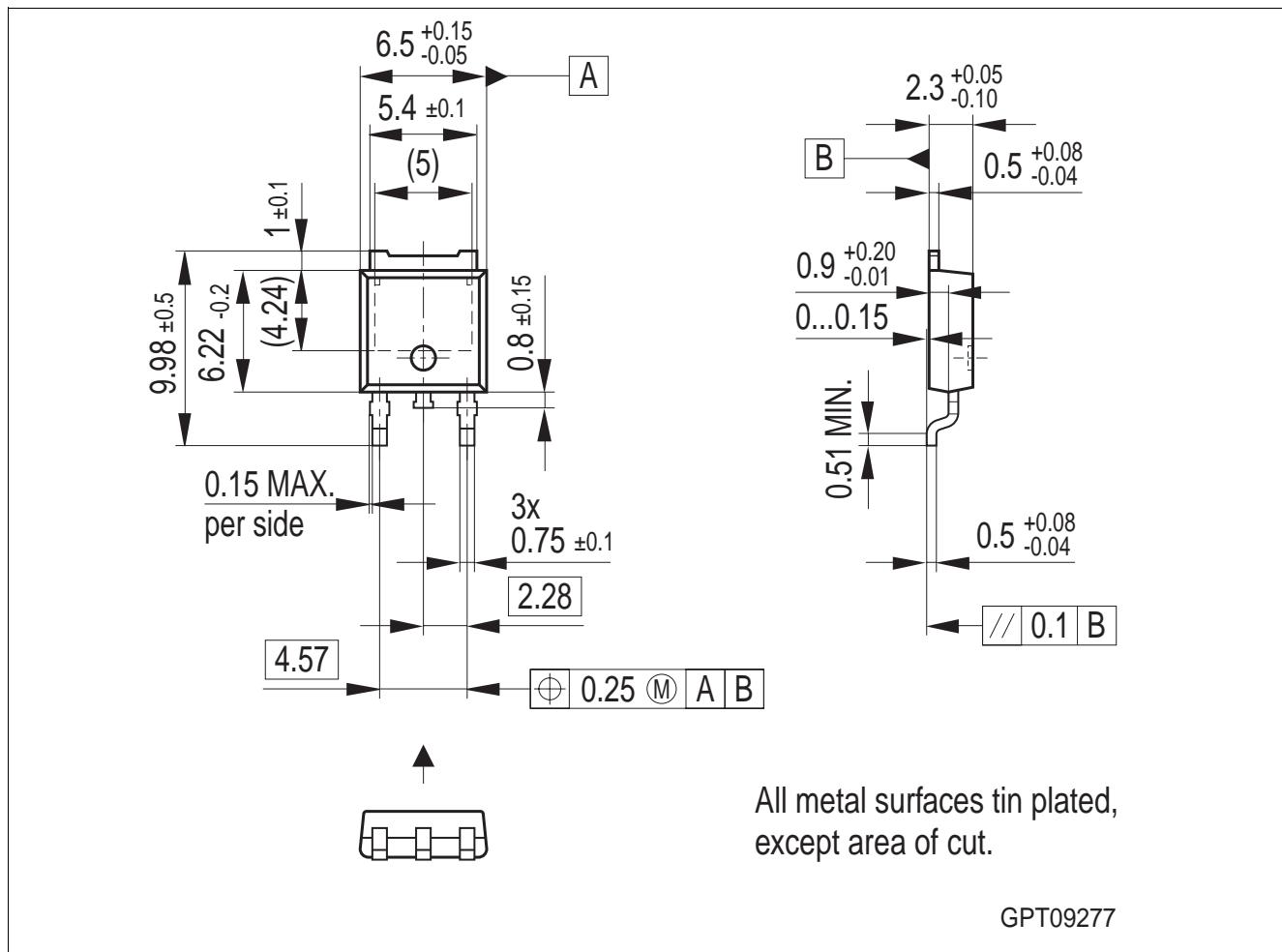


Figure 1 PG-T0252-3-11 (Plastic Dual Small Outline Package) (RoHS-Compliant)

To meet the world-wide customer requirements for environmentally friendly products and to be compliant with government regulations the device is available as a green product. Green products are RoHS-Compliant (i.e Pb-free finish on leads and suitable for Pb-free soldering according to IPC/JEDEC J-STD-020).

Please specify the package needed (e.g. green package) when placing an order

You can find all of our packages, sorts of packing and others in our Infineon Internet Page "Products": <http://www.infineon.com/products>.

Dimensions in mm

2 Revision History

Edition 2006-12-22

Published by
Infineon Technologies AG
81726 Munich, Germany

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